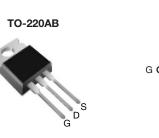
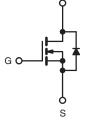


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.28				
Q _g (Max.) (nC)	130				
Q _{gs} (nC)	33				
Q _{gd} (nC)	59				
Configuration	Single				





N-Channel MOSFET

FEATURES

• Low Gate Charge Q_q results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS Ruggedness COMPLIANT
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Low t_{rr} and Soft Diode Recovery
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- ZVS and High Frequency Circuit
- PWM Inverters

ORDERING INFORMATION			
Package	TO-220AB		
Load (Dh) free	IRFB17N50LPbF		
Lead (Pb)-free	SiHFB17N50L-E3		
SnPb	IRFB17N50L		
	SiHFB17N50L		

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	V	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	I _D	16		
Continuous Drain Current	VGS at 10 V	T _C = 25 °C T _C = 100 °C		11	А	
Pulsed Drain Current ^a			I _{DM}	64		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	390	mJ	
Repetitive Avalanche Current ^a			I _{AR}	16	А	
Repetitive Avalanche Energy ^a			E _{AR}	22	mJ	
Maximum Power Dissipation T _C = 25 °C			PD	220	W	
Peak Diode Recovery dV/dt ^c			dV/dt	13	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	℃	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25 \text{ °C}$, L = 3.0 mH, $R_g = 25 \Omega$, $I_{AS} = 16 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 16$ A, dI/dt ≤ 347 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS	-1						
PARAMETER	SYMBOL	ТҮР	TYP. MAX.			UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - - 0.56						
Case-to-Sink, Flat, Greased Surface	R _{thCS}				°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
	alaaa athamu	ico notod)						
SPECIFICATIONS (T _J = 25 °C, u PARAMETER	SYMBOL	1		10	MAINI	TVD		
	STIVIDUL	IES	T CONDITIO	15	MIN.	TYP.	MAX.	UNIT
Static	N		0.1/ 1 050	•	500			
Drain-Source Breakdown Voltage	V _{DS}		= 0 V, I _D = 250	-	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	1	e to 25 °C, I _D		-	0.6	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	-	= V _{GS} , I _D = 250	μA	3.0	-	5.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current	IDSS	-	= 500 V, V _{GS} =		-	-	50	μA
	_	-	/, V _{GS} = 0 V, T,	-	-	-	2.0	mA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	U U	9.9 A ^b	-	0.28	0.32	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = 9.9	Ap	11	-	-	S
Dynamic						1	1	
Input Capacitance	C _{iss}		V _{GS} = 0 V,		-	2760	-	
Output Capacitance	C _{oss}	V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	325	-		
Reverse Transfer Capacitance	C _{rss}	1 = 1	.0 MITZ, See IIQ	J. 5	-	37	-	рF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 1.0 V	, f = 1.0 MHz	-	3690	-	
Output Capacitance		$V_{GS} = 0 V$	$V_{DS} = 400 V$, f = 1.0 MHz	-	84	-	
Effective Output Capacitance	Coss eff.	$V_{GS} = 0 V$	$V_{DS} = 0 V$	' to 400 V ^c	-	159	-	
Total Gate Charge	Qg				-	-	130	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$		/ _{DS} = 400 V, 5 and 13 ^b	-	-	33	
Gate-Drain Charge	Q _{gd}		eee ngi t		-	-	59	
Turn-On Delay Time	t _{d(on)}				-	21	-	
Rise Time	t _r	- V_D =	= 250 V, I _D = 1	6 A,	-	51	-	- ns
Turn-Off Delay Time	t _{d(off)}		7.5 Ω , see fig.		-	50	-	
Fall Time	t _f	1		-	28	-	1	
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	,	MOSFET symbol		-	-	16	
Pulsed Diode Forward Current ^a	I _{SM}	showing the integral reverse p - n junction diode		-	-	64	A	
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V ^b		-	-	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}$ $T_J = 125 \text{ °C}$		-	170	250	ns	
				-	220	330		
Body Diode Reverse Recovery Charge	Q _{rr}	T _J = 25 °C	$I_F = 16 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^{\text{b}}$		-	470	710	nC
		T _J = 125 °C			-	810	1210	
Reverse Recovery Current	I _{RRM}	0.200	I		-	7.3	11	A
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)						

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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V_{DS} = 50 V

8.0

20 µs PULSE WIDTH

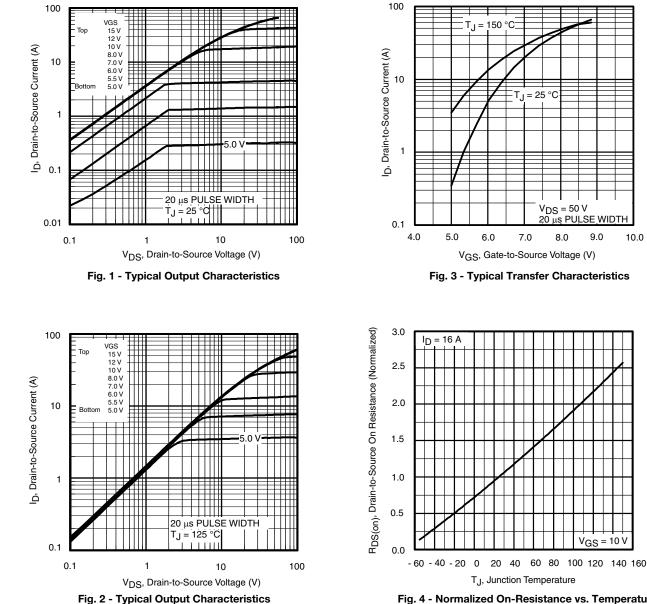
9.0

VGS

10 V

10.0

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 4 - Normalized On-Resistance vs. Temperature

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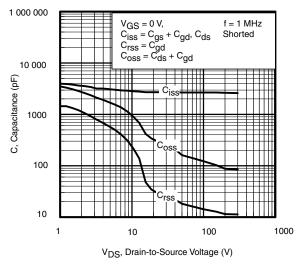
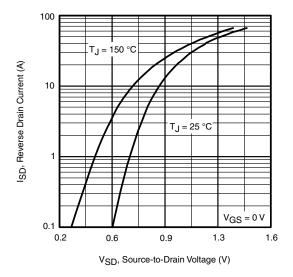


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





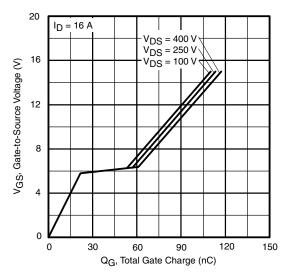


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

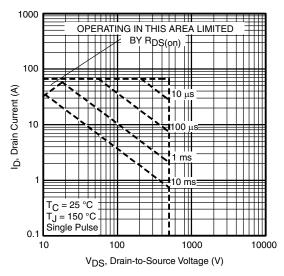


Fig. 8 - Maximum Safe Operating Area

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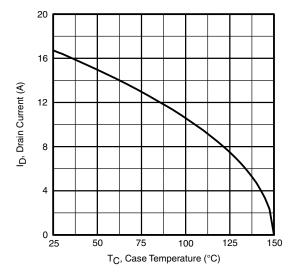


Fig. 9 - Maximum Drain Current vs. Case Temperature

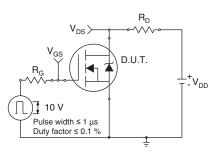


Fig. 10a - Switching Time Test Circuit

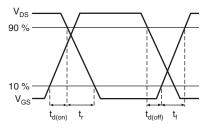


Fig. 10b - Switching Time Waveforms

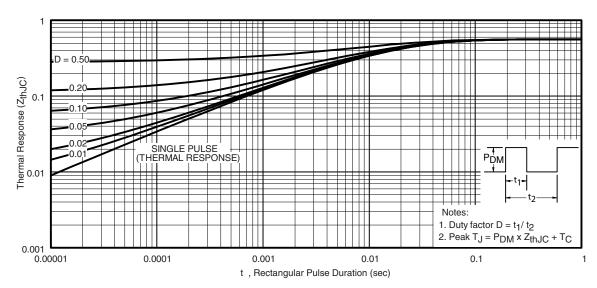


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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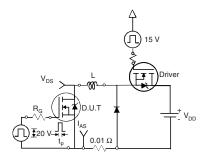


Fig. 12a - Unclamped Inductive Test Circuit

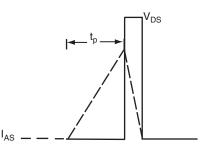


Fig. 12b - Unclamped Inductive Waveforms

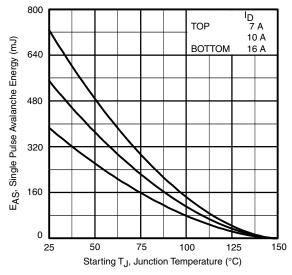


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

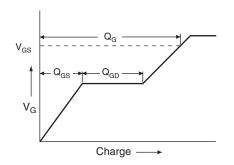


Fig. 13a - Basic Gate Charge Waveform

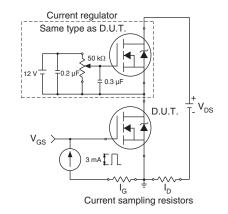
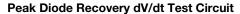


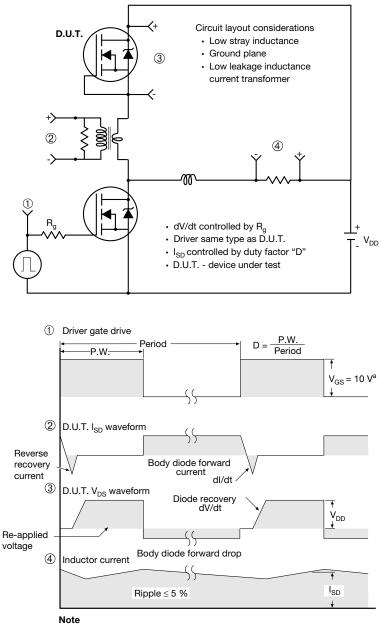
Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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